L Number	Hits	Search Text	DB	Time stamp
1	23	'Y' near wiring near lines	USPAT;	2004/05/31 12:13
		_	US-PGPUB;	,
		•	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
2	18	'X' near wiring near lines	USPĀT;	2004/05/31 12:13
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
4	9	('Y' near wiring near lines) and ('X' near wiring near lines)	USPĀT;	2004/05/31 12:41
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
5	1	('X' near wiring near lines) and LCD	USPĀT;	2004/05/31 12:41
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
6	1	('Y' near wiring near lines) and LCD	USPAT;	2004/05/31 12:42
,		, ,	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
8	3	('X' near wiring near lines) and board	USPAT;	2004/05/31 12:42
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
7	5	('Y' near wiring near lines) and board	USPAT;	2004/05/31 12:42
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
17	242	(257/266).CCLS.	USPAT;	2004/05/31 13:31
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	
18	6	((257/266).CCLS.) and multilayer	USPAT;	2004/05/31 13:32
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
19	350	(257/709) CCL 9	IBM_TDB	2004/05/21 12:21
17	330	(257/798).CCLS.	USPAT; US-PGPUB;	2004/05/31 13:31
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
20	11	((257/798).CCLS.) and multilayer	USPAT;	2004/05/31 13:56
20	11	((25 11 70). CCLG.) and multilayer	US-PGPUB;	200410313113.30
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
21	2	("6556264").PN.	USPAT;	2004/05/31 13:54
-1		( 0000001 ):111.	US-PGPUB;	#6.61 16.60 H-004
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
		<u> </u>	1 ***** 1 1 7 1	L

22	0	(315/169a).CCLS.	USPAT;	2004/05/31 13:55
		(515/1074).0000.	US-PGPUB;	200 1103/31 13.33
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
23	0	(315/169).CCLS.	USPAT;	2004/05/31 13:55
25	Ŭ	(313/107).0025.	US-PGPUB;	200 1103/31 13:33
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
24	2784	(174/255,260).CCLS.	USPAT;	2004/05/31 13:55
		(**************************************	US-PGPUB;	
			ЕРО; ЛРО;	
ļ			DERWENT;	
			IBM_TDB	
25	608	((174/255,260).CCLS.) and multilayer	USPAT;	2004/05/31 13:56
		((*************************************	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
26	161	(((174/255,260).CCLS.) and multilayer) and electrodes	USPAT;	2004/05/31 13:56
		(((,,,,,,,,,	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
27	395	(((174/255,260).CCLS.) and multilayer) and (electrodes or wirings)	USPĀT;	2004/05/31 13:56
			US-PGPUB;	
			ЕРО; ЈРО;	
1			DERWENT;	
			IBM_TDB	
28	179	(((((174/255,260).CCLS.) and multilayer) and (electrodes or wirings))	USPAT;	2004/05/31 13:57
4		and (insulat\$3 adj layer) and (substrate or board)	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
29	179	((((((174/255,260).CCLS.) and multilayer) and (electrodes or wirings))	USPAT;	2004/05/31 13:57
		and (insulat\$3 adj layer) and (substrate or board)) and (substrate or	US-PGPUB;	
		board)	ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
-	1158	349/\$.ccls. and multilayer	USPAT;	2004/05/31 13:25
			US-PGPUB;	
1			EPO; JPO;	
			DERWENT;	
	899	(349/\$.ccls. and multilayer) and electrodes	IBM_TDB USPAT;	2004/05/31 13:56
-	899	(34976.0018. and multilayer) and electrodes	USPAT; US-PGPUB;	2004/03/31 13:30
1	*		EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	908	(349/\$.ccls. and multilayer) and (electrodes or wirings)	USPAT;	2004/05/31 13:56
[ -	,00	(5 157 \$. cold. and martinger) and (electrodes of wirings)	US-PGPUB;	2007/03/31 13.30
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	241	((349/\$.ccls. and multilayer) and (electrodes or wirings)) and (insulat\$3	USPAT;	2004/05/31 10:21
		adj layer)	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
		· · · · · · · · · · · · · · · · · · ·		

	230	(((349/\$.ccls. and multilayer) and (electrodes or wirings)) and (insulat\$3	USPAT;	2004/05/31 13:57
_	230	adj layer)) and (substrate or board)	US-PGPUB;	2004/03/31 13:37
		auj layer)) and (substrate of board)		
		·	EPO; JPO;	
			DERWENT;	
	427	245/01 114:1	IBM_TDB	2004/05/21 10:21
-	437	345/\$.ccls. and multilayer	USPAT;	2004/05/31 10:21
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	:
			IBM_TDB	
-	275	(345/\$.ccls. and multilayer) and electrodes	USPAT;	2004/05/31 10:20
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
-	275	((345/\$.ccls. and multilayer) and electrodes) and (electrodes or wirings)	USPAT;	2004/05/31 10:20
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
-	85	(((345/\$.ccls. and multilayer) and electrodes) and (electrodes or	USPAT;	2004/05/31 10:20
		wirings)) and (insulat\$3 adj layer)	US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
-	80	(((((345/\$.ccls. and multilayer) and electrodes) and (electrodes or	USPAT;	2004/05/31 10:20
İ		wirings)) and (insulat\$3 adj layer)) and (substrate or board)	US-PGPUB;	
		( custains of source)	ЕРО; ЈРО;	
İ			DERWENT;	
			IBM TDB	
1_	15070	257/\$.ccls. and multilayer	USPAT;	2004/05/31 10:24
-	13070	257/\(\psi\).cois. and martinayer	US-PGPUB;	2004/05/51 10:24
			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
ļ	7682	(257/\$.ccls. and multilayer) and electrodes	USPAT;	2004/05/31 10:21
-	7082	(257/5.ccis. and materiayer) and electrodes	US-PGPUB;	2004/03/31 10.21
			EPO; JPO;	
			DERWENT;	
	7602	((257/\$ cole and multileyer) and electrodes) and (electrodes or wirings)	IBM_TDB	2004/05/21 10:22
-	7682	((257/\$.ccls. and multilayer) and electrodes) and (electrodes or wirings)	USPAT; US-PGPUB;	2004/05/31 10:23
i				
	1		EPO; JPO; DERWENT;	
			1	
Ì	2007	(((257/\$ cole and multilayer) and alcotrodos) and (alcotrodos and	IBM_TDB	2004/05/21 10:22
-	3097	(((257/\$.ccls. and multilayer) and electrodes) and (electrodes or	USPAT;	2004/05/31 10:22
		wirings)) and (insulat\$3 adj layer)	US-PGPUB;	
İ	1		ЕРО; ЛРО;	
	i		DERWENT;	
		///0551/0 1 1 1/1 > 1 1 / 1 > 1 1 / 1 > 1 / 1 > 1 / 1 > 1 / 1   1 / 1	IBM_TDB	2004/05/21 10 5
-	3030	((((257/\$.ccls. and multilayer) and electrodes) and (electrodes or	USPAT;	2004/05/31 10:22
	i	wirings)) and (insulat\$3 adj layer)) and (substrate or board)	US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
	1		IBM_TDB	
-	1848	(257/\$.ccls. and multilayer) and display	USPAT;	2004/05/31 10:23
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
L	<u> </u>		IBM_TDB	

	1540	100000	L TTOTO A CT	0004/05/01 10 00
-	1543	((257/\$.ccls. and multilayer) and display) and (electrodes or wirings)	USPAT;	2004/05/31 10:23
			US-PGPUB;	
			ЕРО; ЛРО;	
į.			DERWENT;	
:		//255/0	IBM_TDB	2004/05/01 10 25
-	62	(((257/\$.ccls. and multilayer) and display) and (electrodes or wirings))	USPAT;	2004/05/31 10:27
Į.		and ('same' near plane)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	2707	257/011/I OD 1::1 1:1>	IBM_TDB	2004/05/21 10:25
<del>-</del>	3727	257/\$.ccls. and(LCD liquid near display)	USPAT;	2004/05/31 10:25
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT; IBM_TDB	
	1197	(257/\$.ccls. and(LCD liquid near display)) and wiring	USPAT;	2004/05/31 10:26
-	1197	(257/4.ccis. and(LCD inquid liear display)) and wiring	US-PGPUB;	2004/03/31 10.20
			EPO; JPO;	ı
			DERWENT;	
			IBM_TDB	
l _	1154	((257/\$.ccls. and(LCD liquid near display)) and wiring) and substrate	USPAT;	2004/05/31 10:27
ŀ	113.	(25 // 0.0015. una(15015 inquite neur unspiny)) una wiring) una sussaure	US-PGPUB;	200 11 03/31 10:27
:			ЕРО; ЛРО;	
			DERWENT;	
			IBM TDB	
-	74	(((257/\$.ccls. and(LCD liquid near display)) and wiring) and substrate)	USPAT;	2004/05/31 13:24
·		and ('same' near plane)	US-PGPUB;	
		·	ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
-	4	09/751614	USPAT;	2004/05/31 12:12
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	